
**Modular Jack, Single or Dual Port, Surface Mount or Thru-Hole,
Economy**

1. SCOPE

1.1. Content

This specification covers performance, tests and quality requirements for the AMP* surface mount or thru-hole (.040 inch centerline) single or dual port modular jack pick and place solderable hold down for data or telephone modular plugs.

1.2. Qualification

When tests are performed on the subject product line, procedures specified in Figure 1 shall be used. All inspections shall be performed using the applicable inspection plan and product drawing.

1.3. Qualification Test Results

Successful qualification testing on the subject product line was completed on 03Jan97. The test file number for this testing is CTL 8162-004-001. This documentation is on file at and available from the Americas Regional Laboratory.

2. APPLICABLE DOCUMENTS

The following documents form a part of this specification to the extent specified herein. Unless otherwise specified, the latest edition of the document applies. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

2.1. AMP Documents

- A. 109-1: General Requirements for Test Specifications
- B. 109 Series: Test Specifications as indicated in Figure 1
- C. Corporate Bulletin 401-76: Cross-reference between AMP Test Specifications and Government or Commercial Documents
- D. 501-392: Qualification Test Report

2.2. Commercial Specification

FCC Rules for Registration of Telephone Equipment Part 68, Subpart F, Connectors

3. REQUIREMENTS

3.1. Design and Construction

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2. Materials

- A. Contact: Phosphor bronze, nickel plated with selective gold plating on contact area and tin-lead plating on solder area
- B. Housing: Thermoplastic, UL 94V-0

3.3. Ratings

- A. Voltage: 150 vac
- B. Current: Signal application only
- C. Temperature: 70°C

3.4. Performance and Test Description

Product is designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1. Unless otherwise specified, all tests shall be performed at ambient environmental conditions per AMP Specification 109-1.

3.5. Test Requirements and Procedures Summary

Test Description	Requirement	Procedure
Examination of product.	Meets requirements of product drawing.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Termination resistance.	ΔR 30 milliohms maximum.	AMP Spec 109-6-1. Subject mated samples to 50 mv maximum open circuit at 100 ma maximum. See Figure 3.
Dielectric withstanding voltage.	1000 vac at sea level. 1 minute hold with no breakdown or flashover.	AMP Spec 109-29-1. Test between adjacent contacts of mated samples.
MECHANICAL		
Vibration, random.	No discontinuities of 1 microsecond or longer duration. See Note.	AMP Spec 109-21-7. Subject mated samples to 1.57 G's rms between 10-500 Hz. 15 minutes in each of 3 mutually perpendicular planes.
Durability.	See Note.	AMP Spec 109-27. Mate and unmate samples for 250 cycles at a maximum rate of 600 cycles per hour.
Unmating force.	5 pounds maximum.	AMP Spec 109-42, Condition A. Measure force necessary to unmate samples with latch depressed at a maximum rate of .5 inch per minute.

Figure 1 (cont)

Test Description	Requirement	Procedure
Plug retention in jack.	Plug shall not dislodge from jack.	AMP Spec 109-50. Apply axial load of 20 pounds to plug housing mated in jack with latch engaged at a maximum rate of .5 inch per minute.
Jack retention to printed circuit board.	Jack shall not dislodge from printed circuit board.	AMP Spec 109-50. Apply perpendicular load of 10 pounds to jack mounted on a .062 inch thick printed circuit board at a maximum rate of 2 inches per minute.

NOTE *Shall meet visual requirements, show no physical damage and shall meet requirements of additional tests as specified in Test Sequence in Figure 2.*

Figure 1 (end)

3.6. Product Qualification and Requalification Test Sequence

Test or Examination	Test Group (a)		
	1	2	3
	Test Sequence (b)		
Examination of product	1,7	1,3	1,4
Termination resistance	2,5		
Dielectric withstanding voltage		2	
Vibration	4		
Durability	3		
Unmating force	6		
Plug retention in jack			2
Jack retention to printed circuit board			3

NOTE (a) *See Para 4.1.A.*
(b) *Numbers indicate sequence in which tests are performed.*

Figure 2

4. QUALITY ASSURANCE PROVISIONS

4.1. Qualification Testing

A. Sample Selection

Samples shall be prepared in accordance with applicable Instruction Sheets and shall be selected at random from current production. All test groups shall consist of 10 plugs and jacks.

B. Test Sequence

Qualification inspection shall be verified by testing samples as specified in Figure 2.

4.2. Requalification Testing

If changes significantly affecting form, fit or function are made to the product or manufacturing process, product assurance shall coordinate requalification testing, consisting of all or part of the original testing sequence as determined by development/product, quality and reliability engineering.

4.3. Acceptance

Acceptance is based on verification that the product meets the requirements of Figure 1. Failures attributed to equipment, test setup or operator deficiencies shall not disqualify the product. When product failure occurs, corrective action shall be taken and samples resubmitted for qualification. Testing to confirm corrective action is required before resubmittal.

4.4. Quality Conformance Inspection

Applicable AMP quality inspection plan will specify the sampling acceptable quality level to be used. Dimensional and functional requirements shall be in accordance with the applicable product drawing and this specification.

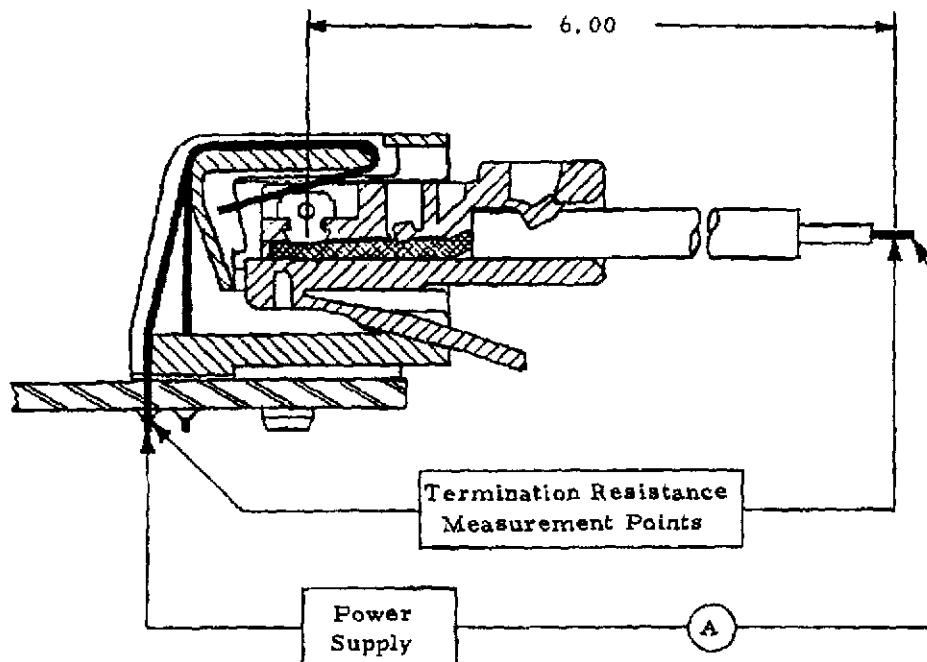


Figure 3
Termination Resistance Measurement Points